TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified						
PARAMETER	SYMBOL	VALUE	UNITS			
Peak Pulse Power (tp = 8/20µs) - See Figure 1	P _{pp}	250	Watts			
Operating Temperature	T _A	-55 to 150	°C			
Storage Temperature	T _{stg}	-55 to 150	°C			

PART RATED MINIMUM MAXIMUM MAXIMUM MAXIMUM TY	PICAL CITANCE
$\begin{array}{c c c c c c c c c c c c c c c c c c c $, 1MHz C pF
P0402FC3.3C 3.3 4.0 7.0 12.5V @ 20A 75*	150
P0402FC05C 5.0 6.0 11.0 14.7V @ 17A 10**	100
P0402FC08C 8.0 8.5 13.2 19.2V @ 13A 10***	75
P0402FC12C 12.0 13.3 19.8 29.7V @ 9A 1	50
P0402FC15C 15.0 16.7 25.4 35.7V @ 7A 1	40
P0402FC24C 24.0 26.7 37.2 55.0V @ 5A 1	30
P0402FC36C 36.0 40.0 70.0 84.0V @ 3A 1	25

NOTES

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All devices are bidirectional. Electrical characteristics apply in both directions.
*Maximum leakage current < 5μA @ 2.8V. **Maximum leakage current < 500nA @ 3.3V. ***Maximum leakage current < 200nA @ 5V.

TYPICAL DEVICE CHARACTERISTICS

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TYPICAL DEVICE CHARACTERISTICS

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Only One Name Means ProTek'Tion™

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SPICE MODEL

FIGURE 1 SPICE MODEL FOR



ABD - Avalanche Breakdown Diode (TVS)

TABLE 1 - SPICE PARAMETERS							
PARAMETER	PARAMETER UNIT						
BV	V	See Table 2					
IBV	μΑ	1					
C _{jo}	pF	See Table 2					
I _s	А	See Table 2					
Vj	V	0.6					
м	-	0.33					
N	-	1					
R _s	-	See Table 2					
TT	S	1E-8					
EG	eV	1.11					

TABLE 2 - ABD SPECIFIC SPICE PARAMETERS								
PART NUMBER	PART NUMBER B _v (VOLTS) C _{io} (pF) I _s (AMPS)							
P0402FC3.3C	4.0	150	1E-11	0.20				
P0402FC05C	6.0	100	1E-11	0.16				
P0402FC08C	8.5	75	1E-13	0.33				
P0402FC12C	13.3	50	1E-13	0.51				
P0402FC15C	16.7	40	1E-13	0.53				
P0402FC24C	26.7	20	1E-13	0.63				
P0402FC36C	40.2	15	1E-13	0.73				

SOLDER REFLOW INFORMATION

PRINTED CIRCUIT BOARD RECOMMENDATIONS						
PARAMETER VALUE						
Pad Size on PCB	0.275mm					
Pad Shape	Round					
Pad Definition	Non-Solder Mask Defined Pads					
Solder Mask Opening	0.325mm Round					
Solder Stencil Thickness	0.150mm					
Solder Stencil Aperture Opening (Laser cut, 5% tapered walls)	0.330mm Round					
Solder Paste Type	No Clean					
Pad Protective Finish	OSP (Entek Cu Plus 106A)					
Tolerance - Edge To Corner Ball	±50μm					
Solder Ball Side Coplanarity	±20μm					
Maximum Dwell Time Above Liquidous (183°C)	60 seconds					
Soldering Maximum Temperature	270°C					

REQUIREMENTS

RECOMMENDED NON-SOLDER MASK DEFINED PAD ILLUSTRATION



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0402 PACKAGE INFORMATION

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OUTLINE DIMENSIONS							
DIM	MILLIN	IETERS	INCHES				
	MIN	MAX	MIN	MAX			
А	0.	46	0.0)18			
В	0.	86	0.034				
С	0.98	1.02	0.038 0.040				
D	0.	10	0.004				
E	0.35		0.0)14			
F	0.458	0.508	0.018 0.02				
G	0.	20	0.008				
н	0.051	0.076	0.002 0.00				
I	0.4	106	0.016				
NOTES	NOTES						

Controlling dimensions in inches.
Decimal tolerance: .xxx ± 0.05mm (0.002").

3. Maximum chip size: 1.02mm (0.040") by 0.51mm (0.020").





LAYOUT DIMENSIONS							
DIM	MILLIMETERS	INCHES					
	NOMINAL	NOMINAL					
А	0.23	0.009					
В	0.48	0.019					
С	0.69	0.027					
D	0.46	0.018					
E	0.99	0.039					
F	0.20	0.008					
G	0.20	0.008					
н	0.66	0.026					
I	0.13	0.005					
NOTES 1. Controlling dimensions in inches.							

2. Decimal tolerance: .xxx \pm 0.05mm (0.002").



TAPE AND REEL INFORMATION

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User Direction of Feed

SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	ко	D	E	F	w	PO	P2	Р	Tmax
178(7")	8	0.70 ± 0.05	1.15 ± 0.10	0.56 ± 0.05	1.55 ± 0.05	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.20	4.00 ± 0.05	2.00 ± 0.05	4.00 ± 0.05	0.25
NOTES 1. Dimensions in n 2. Top view of tape 3. Orientation: pre 4. Surface mount p 5. 8mm plastic tap 6. Marking on Ree	nillimeters. e. Metal conf ferred stenci product is tag e: 7" Reels - 1 - part numb	acts are face of I - 0.1mm (0.00 ved and reeled 5,000 pieces p er, date code a	down in tape p 04"). in accordance er reel. and lot numbe	ackage. with EIA 481. r.				TAPE &	REEL ORI		J	

ORDERING INFORMATION								
BASE PART NUMBER (xx = Voltage)	T NUMBER LEADFREE SUFFIX TAPE SUFFIX QTY/REEL REEL SIZE TUB							
P0402FCxxC	-LF	-T75-1	5,000	7"	n/a			
This device is only available in a Lead-Free configuration.								

COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices[™] is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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